PRELIMINARY SPEC

## 3.5 x2.8mm SMD CHIP LED LAMP

Part Number: APED3528ZGC/G-F01 Green



ATTENTION OBSERVE PRECAUTIONS FOR HANDLING ELECTROSTATIC DISCHARGE SENSITIVE DEVICES

#### Features

- Single color.
- Suitable for all SMT assembly and solder process.
- Ideal for backlighting.
- Available on tape and reel.
- Package: 500pcs / reel.
- Moisture sensitivity level : level 3.
- RoHS compliant.

#### Description

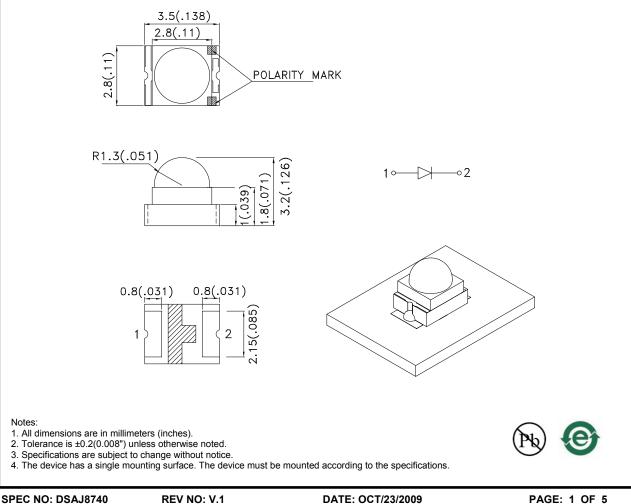
The Green source color devices are made with InGaN Light Emitting Diode.

Static electricity and surge damage the LEDS.

It is recommended to use a wrist band or anti-electrostatic glove when handling the LEDs.

All devices, equipment and machinery must be electrically grounded.

### **Package Dimensions**



APPROVED: WYNEC

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DATE: OCT/23/2009 DRAWN: M.L.Xu PAGE: 1 OF 5 ERP: 1203010173

### Selection Guide

Delection Guide					
Part No.	Dice	Lens Type	lv (mcd) [2] @ 20mA		Viewing Angle [1]
			Min.	Тур.	201/2
APED3528ZGC/G-F01	Green (InGaN)	WATER CLEAR	2200	3000	40°

Notes:

θ1/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value.
Luminous intensity/ luminous Flux: +/-15%.

### Electrical / Optical Characteristics at TA=25°C

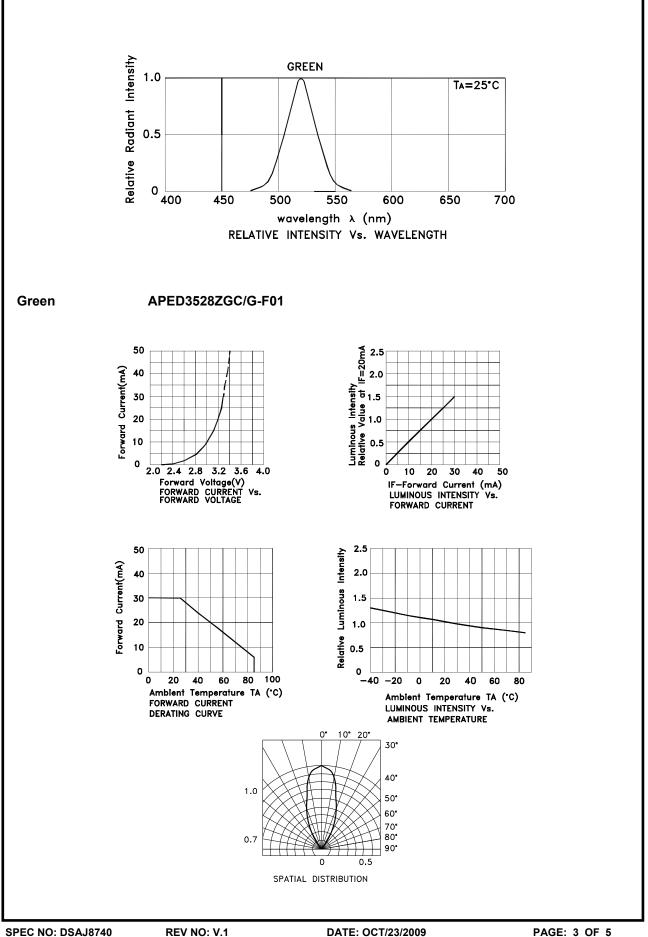
Symbol	Parameter	Device	Тур.	Max.	Units	Test Conditions	
λpeak	Peak Wavelength	Green	520		nm	I⊧=20mA	
λD [1]	Dominant Wavelength	Green	525		nm	IF=20mA	
Δλ1/2	Spectral Line Half-width	Green	35		nm	I⊧=20mA	
С	Capacitance	Green	100		pF	VF=0V;f=1MHz	
VF [2]	Forward Voltage	Green	3.2	4	V	IF=20mA	
lr	Reverse Current	Green		10	uA	VR=5V	

Notes: 1.Wavelength: +/-1nm. 2. Forward Voltage: +/-0.1V.

### Absolute Maximum Ratings at TA=25°C

Parameter	Green	Units	
Power dissipation	120	mW	
DC Forward Current	30	mA	
Peak Forward Current [1]	100	mA	
Reverse Voltage	5	V	
Operating Temperature	-40°C To +85°C		
Storage Temperature	-40°C To +85°C		

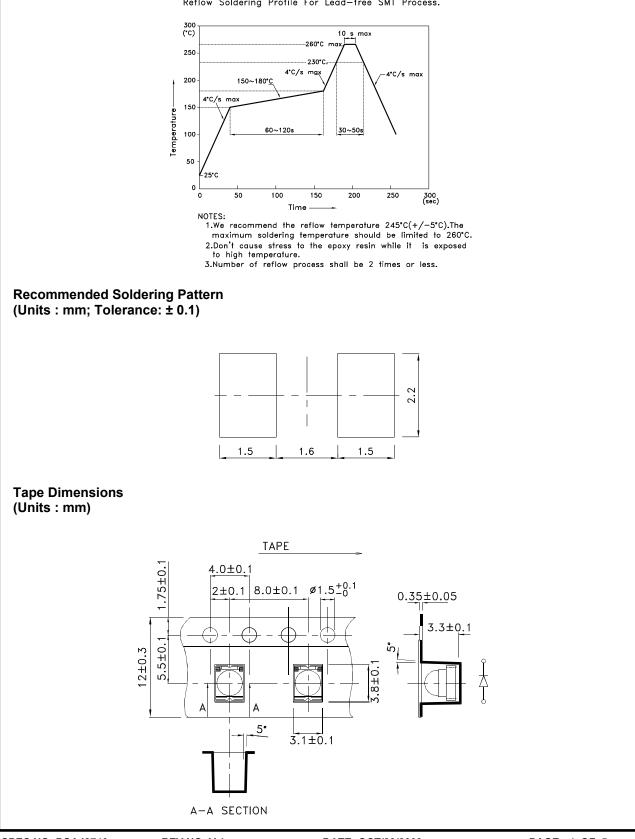
Note: 1. 1/10 Duty Cycle, 0.1ms Pulse Width.



### APED3528ZGC/G-F01

Reflow soldering is recommended and the soldering profile is shown below. Other soldering methods are not recommended as they might cause damage to the product.

Reflow Soldering Profile For Lead-free SMT Process.



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PAGE: 4 OF 5 ERP: 1203010173

